AUTOMOTIV

COMPLIANT

HALOGEN FREE

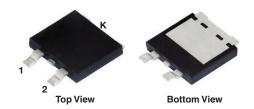


Vishay General Semiconductor

Dual Low-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.36 \text{ V}$ at $I_F = 5.0 \text{ A}$

eSMP[®] Series SMPD (TO-263AC)





LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 15 A			
V _{RRM}	60 V			
I _{FSM}	170 A			
V_F at $I_F = 15 \text{ A } (T_J = 125 ^{\circ}\text{C})$	0.54 V			
T _J max.	150 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Common cathode			

FEATURES

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	V30DL63C	UNIT	
Device marking code			V30DL63C		
Maximum repetitive peak reverse voltage		V _{RRM}	60	V	
Maximum average forward rectified current (fig. 1)	per device	I (1)	30	^	
	per diode	I _{F(AV)} (1)	15	— A	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode		I _{FSM}	170	А	
Operating junction temperature range Storage temperature range		T _J ⁽²⁾	-40 to +150	°C	
		T _{STG}	-55 to +150		

Notes

- (1) Mounted on infinite heatsink
- $^{(2)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I _F = 5 A	T _J = 25 °C	T _J = 25 °C V _F ⁽¹⁾	0.45	-	- V	
	$I_F = 7.5 A$			0.48	-		
	I _F = 15 A			0.58	0.65		
	I _F = 5 A	T _J = 125 °C		0.36	-		
	I _F = 7.5 A			0.41	-		
	I _F = 15 A			0.54	0.62		
Reverse current at rated V _R per diode	V - 60 V	$T_J = 25 ^{\circ}\text{C}$ $T_J = 125 ^{\circ}\text{C}$	I _R ⁽²⁾	-	0.2	mΛ	
	V _R = 60 V		'R (=)	9	20	mA	
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	1900	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER SYMBOL V30DL63C		V30DL63C	UNIT	
Typical thermal resistance per device	R ₀ JC ⁽¹⁾	1.8	°C/W	
	R _{0JA} (2)(3)	58	C/VV	

Notes

- (1) Mounted on infinite heatsink
- $^{(2)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$ junction-to-ambient
- (3) Free air, without heatsink

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
V30DL63C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel			
V30DL63CHM3/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

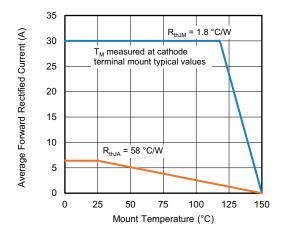


Fig. 1 - Maximum Forward Current Derating Curve

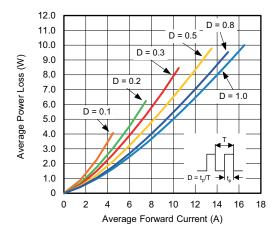


Fig. 2 - Average Power Loss Characteristics Per Diode

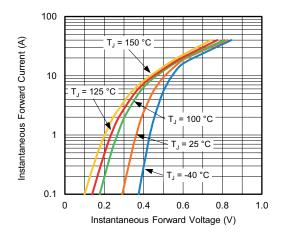


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

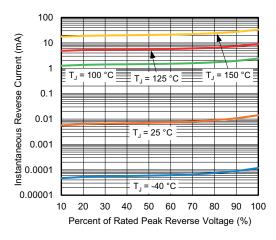


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

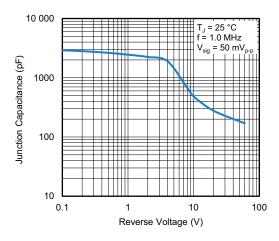


Fig. 5 - Typical Junction Capacitance Per Diode

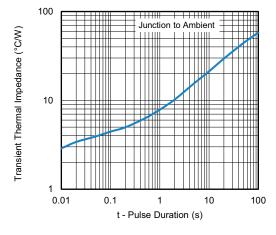
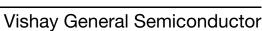


Fig. 6 - Typical Transient Thermal Impedance





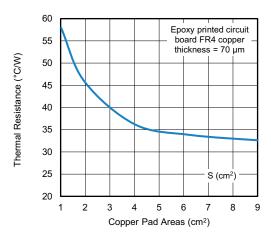


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPD (TO-263AC) 0.402 (10.20) 0.071 (1.80) 0.063 (1.60) 0.386 (9.80) 0.020 (0.52) 0.011 (0.27) 0.059 (1.50) REF. 0.048 (1.21) 0.354 (8.99) 0.509 (12.93) 0.485 (12.33) 0 to 0.01 (0 to 0.254) 0.069 (1.74) 0.053 (1.34) 0.063 (1.60) 0.020 (0.52) 0.047 (1.20) 0.200 (5.08) NOM: 0.052 (1.23) 0.028 (0.72) Mounting Pad Layout 0.420 (10.66) MIN. 0.339 (8.60) 0.276 (7.00) 0.330 (8.38) REF. (4.93) NOM 0.604 (15.33) 0.525 (13.33) 0.120 (3.05) REF. 0.105 (2.67) 0.095 (2.41)

0.080 (2.03) MIN.



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